

Title (en)

A PRINT ADHESIVE LABEL AND AN ADHEREND

Title (de)

GEDRUCKTES KLEBEETIKETT UND KLEBEETIKETT

Title (fr)

ÉTIQUETTE ADHÉSIVE D'IMPRESSION ET PARTIE ADHÉRÉE

Publication

**EP 3712220 A1 20200923 (EN)**

Application

**EP 20159574 A 20200226**

Priority

JP 2019035183 A 20190228

Abstract (en)

Provided is a print adhesive label comprising a release sheet consisting of a release sheet substrate and a release layer, and an adhesive label consisting of a label substrate and an adhesive layer, wherein a print layer with information printed is provided between the release layer and the adhesive layer; the adhesive layer comprises a fluorescence dye; the adhesive layer is pasted on the release layer and the print layer; a surface of the adhesive layer has a region where the print layer does not exist in a planar view; the label substrate is a transparent plastic film; and the adhesive layer is transparent. According to the present invention, a print adhesive label and an adherend using the same, wherein the pasted security label is inconspicuous, and designability of an adherend such as a product is not impaired, can be provided.

IPC 8 full level

**C09J 7/22** (2018.01); **C08K 5/00** (2006.01); **C09J 7/30** (2018.01); **G09F 3/10** (2006.01)

CPC (source: EP)

**C09J 7/22** (2017.12); **C09J 7/30** (2017.12); **G09F 3/0292** (2013.01); **G09F 3/10** (2013.01); **C09J 2203/334** (2013.01); **C09J 2301/408** (2020.08)

Citation (applicant)

WO 9740484 A1 19971030 - MINNESOTA MINING & MFG [US]

Citation (search report)

- [X] US 2002090482 A1 20020711 - MOTOMIYA SEIYA [JP]
- [X] JP 2002205465 A 20020723 - LINTEC CORP
- [X] JP 2002323856 A 20021108 - LINTEC CORP
- [X] EP 0896707 A1 19990217 - MINNESOTA MINING & MFG [US]

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

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DOCDB simple family (publication)

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